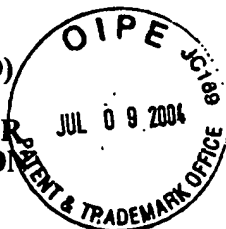


FORM PTO-1449 (MODIFIED)

LIST OF PUBLICATIONS FOR
APPLICANT'S INFORMATION
DISCLOSURE STATEMENT



Applicant(s): T.B. Bambridge et al.
Case: 2-7-1-80
Serial No.: 10/787,010
Filing Date: February 25, 2004
Group: 2857

U.S. PATENT DOCUMENTS

EXAMINER				FILING DATE
INITIAL	DOCUMENT NO.	DATE	NAME	IF APPROPRIATE

FOREIGN PATENT DOCUMENTS

EXAMINER				TRANSLATION	
INITIAL	DOCUMENT NO.	DATE	COUNTRY	CLASS/SUBCLASS	YES NO

OTHER DOCUMENTS

EXAMINER		REF NO.	AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.
----------	--	---------	--

- Cja* 1. V. Solberg, "Adapting Fine-Line Flex Circuits for 3D Multiple Die Packaging," Semiconductor Manufacturing, pp. 94-108, June 2003.

Examiner

C. J. Arbes

Date Considered

2/2/06

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.